

Product Summary (@T_A = +25°C)

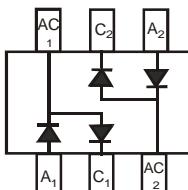
V _{RRM} (V)	I _F (mA)	V _{F(MAX)} (V)	I _{R(MAX)} (μA)
30	200	1	2.0

Description

200mA surface mount Schottky Barrier Diode in SOT363 package, offers low turn-on voltage and fast switching capability, designed with PN Junction Guard Ring for Transient and ESD Protection, totally lead-free finish and RoHS compliant, "Green" device.



Top View



BAT54SDWQ*

*Symmetrical configuration, no orientation indicator.

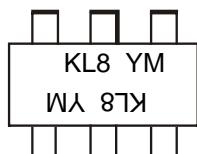
Ordering Information (Note 5)

Part Number	Case	Packaging
BAT54SDWQ-7-F	SOT363	3,000/Tape & Reel

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/product_compliance_definitions.html.
5. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information



KL8 = Product Type Marking Code
 For Symmetrical Configuration, No Orientation Indicator
 YM = Date Code Marking
 Y = Year (ex: D = 2017)
 M = Month (ex: 9 = September)

Date Code Key

Year	2001	2002	...	2011	2012	2013	2014	2015	2016	2017	2018	2019	2020	2021	2022
Code	M	N	...	Y	Z	A	B	C	D	E	F	G	H	I	J
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec			
Code	1	2	3	4	5	6	7	8	9	O	N	D			

Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RMM}		
Working Peak Reverse Voltage	V_{RWM}	30	V
DC Blocking Voltage	V_R		
Forward Continuous Current (Note 6)	I_F	200	mA
Repetitive Peak Forward Current (Note 6)	I_{FRM}	300	mA
Forward Surge Current (Note 6) @ $t < 1.0\text{s}$	I_{FSM}	600	mA

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P_D	200	mW
Thermal Resistance, Junction to Ambient Air (Note 6)	$R_{\theta JA}$	625	°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +125	°C

Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	30	—	—	V	$I_R = 100\mu\text{A}$
Forward Voltage (Note 7)	V_F	—	—	240 320 400 500 1,000	mV	$I_F = 0.1\text{mA}$ $I_F = 1\text{mA}$ $I_F = 10\text{mA}$ $I_F = 30\text{mA}$ $I_F = 100\text{mA}$
Reverse Leakage Current (Note 7)	I_R	—	—	2.0	μA	$V_R = 25\text{V}$
Total Capacitance	C_T	—	—	10	pF	$V_R = 1.0\text{V}$, $f = 1.0\text{MHz}$
Reverse Recovery Time	t_{RR}	—	—	5.0	ns	$I_F = 10\text{mA}$ through $I_R = 10\text{mA}$ to $I_R = 1.0\text{mA}$, $R_L = 100\Omega$

Notes: 6. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout, which can be found on our website at <http://www.diodes.com/package-outlines.html>.

7. Short duration pulse test used to minimize self-heating effect.

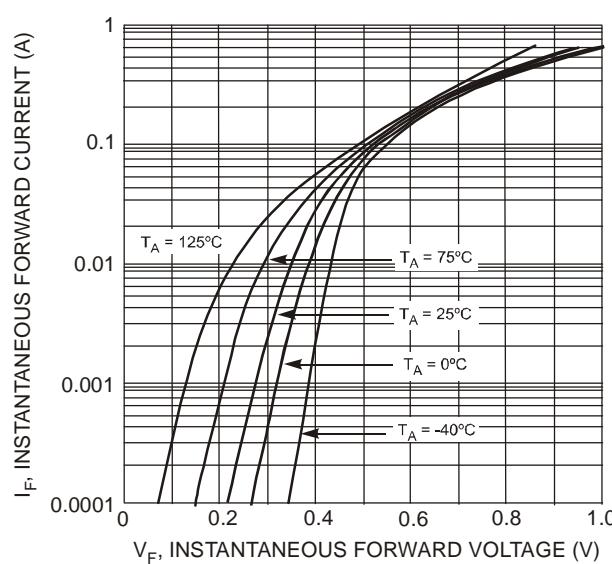


Fig. 1 Typical Forward Characteristics

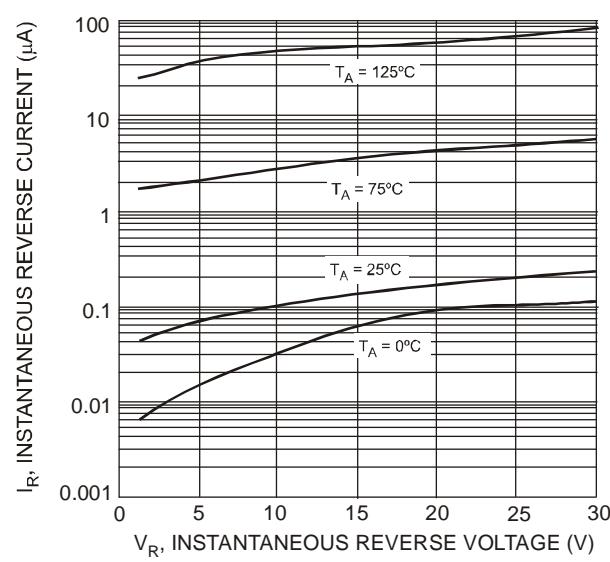


Fig. 2 Typical Reverse Characteristics

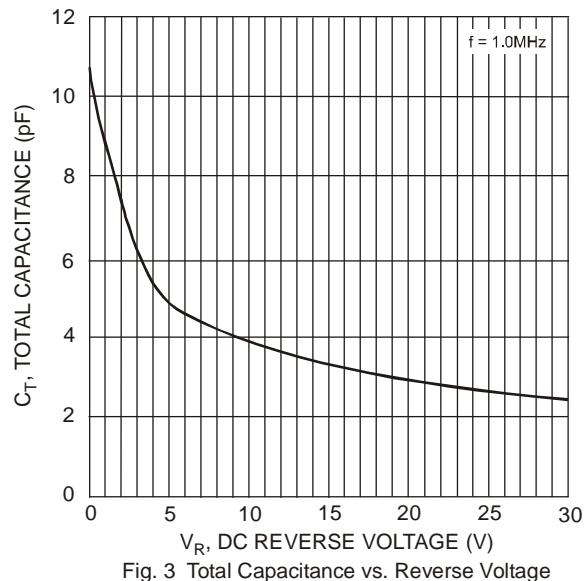


Fig. 3 Total Capacitance vs. Reverse Voltage

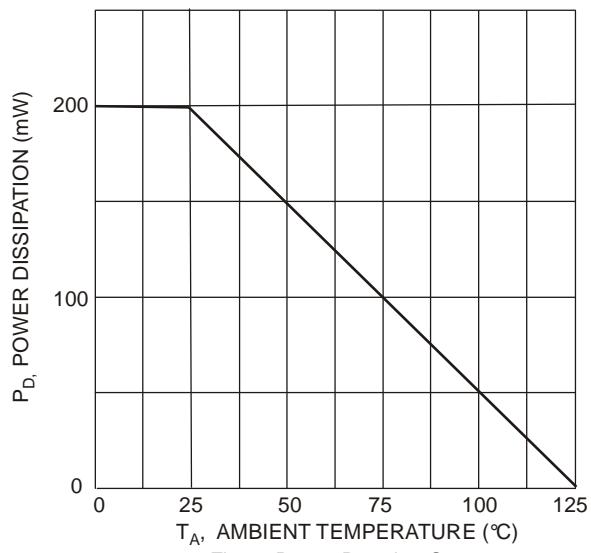
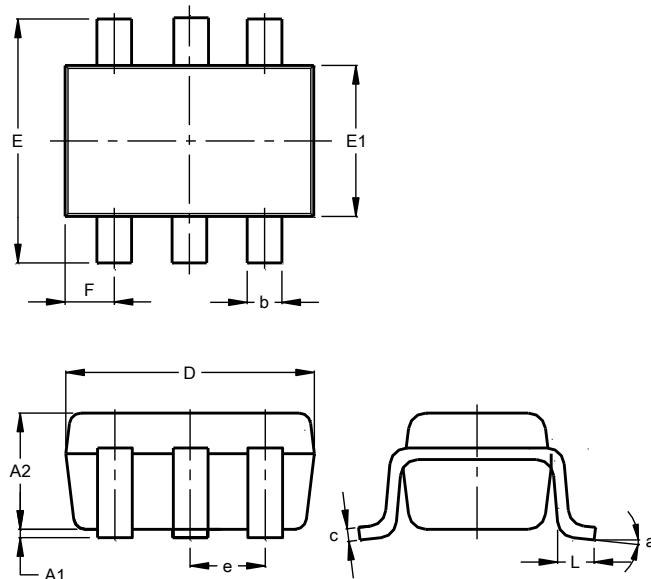


Fig. 4 Power Derating Curve

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT363



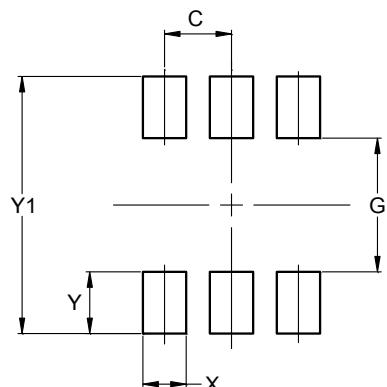
SOT363			
Dim	Min	Max	Typ
A1	0.00	0.10	0.05
A2	0.90	1.00	1.00
b	0.10	0.30	0.25
c	0.10	0.22	0.11
D	1.80	2.20	2.15
E	2.00	2.20	2.10
E1	1.15	1.35	1.30
e	0.650 BSC		
F	0.40	0.45	0.425
L	0.25	0.40	0.30
a	0°	8°	--

All Dimensions in mm

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT363



Dimensions	Value (in mm)
C	0.650
G	1.300
X	0.420
Y	0.600
Y1	2.500

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